

Docket No.: WRA-32830

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Date: July 22, 2002

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor : Karl Draganitsch et al.
Applic. No. : 09/817,573
Filed : March 26, 2001
Title : Method Of Producing A Wafer Product, Assembly For
Implementing The Method, And Wafer Product Produced
According To The Method
Examiner : Thuy Tran Lien - Art Unit: 1761

RESPONSE

Hon. Commissioner of Patents and Trademarks,
Washington, D. C. 20231

Sir:

Responsive to the Office Action dated July 3, 2002, the following remarks are made:

In deference to the restriction requirement on pages 2 and 3 of the above-identified Office Action, applicants elect group I, claims 1-6, for prosecution at this time.

Applicants reserve the right to file a divisional application including the device claims of group II at a later date.

In view of the foregoing, the early issuance of an Action on the merits of claims 1-6 is solicited.

Respectfully submitted,


For Applicants

Date: July 22, 2002

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